

S	PECIFI	CATIONS			
CUSTOMER	:	РТС			
SAMPLE CODE	:	SH480272T005-IAC02			
MASS PRODUCTION CODE	:	PH480272T005-IAC02			
SAMPLE VERSION	:	01			
SPECIFICATIONS EDITION	:	004			
DRAWING NO. (Ver.)	:	JLMD- PH480272T005-IAC02_003			
PACKAGING NO. (Ver.)	:	JPKG- PH480272T005-IAC02_001			
Cu	stomer	Approved			
		Date:			
Approved		Date: ecked Designer			

劉進 劉進 俞承澤

- □ Preliminary specification for design input
- Specification for sample approval

## POWERTIP TECH. CORP.

Headquarters:

No.8, 6th Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8號

TEL: 886-4-2355-8168 FAX: 886-4-2355-8166 E-mail: sales@powertip.com.tw

Http://www.powertip.com.tw



# **History of Version**

Date	Ver.	Edi.	Description	Page	Design by
11/28/2017	01	001	New Drawing	-	徐明菲
11/30/2017	01	002	Modify Specification (Modify LCM Drawing & 1.6 Backlight Characteristics)	Appendix 8	徐明菲
01/25/2018	01	003	New Sample	-	徐明菲
12/01/2020	01	004	Modify Touch Panel Characteristics	10	俞承澤



## Contents

# **1. SPECIFICATIONS**

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- **1.4 DC Electrical Characteristics**
- 1.5 Optical Characteristics
- **1.6 Backlight Characteristics**
- 1.7 Touch Panel Characteristics

# 2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics

## **3. QUALITY ASSURANCE SYSTEM**

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

### 4. RELIABILITY TEST

4.1 Reliability Test Condition

## **5. PRECAUTION RELATING PRODUCT HANDLING**

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix : 1. LCM Drawing

2. LCM Packaging

Note: For detailed information please refer to IC data sheet:Sitronix--- ST7257



### 1.1 Features

Item	Standard Value
Display Type	480 * 3 (RGB) * 272 Dots
LCD Type	Normally white TN, Transmissive Type
Screen size(inch)	4.3"(Diagonal)
Viewing Direction	6 O'clock
Color configuration	R,G, B vertical stripe
Backlight	White LED B/L
Display Interface	Digital 24-bits RGB
Driver IC	ST7257
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

## 1.2 Mechanical Specifications

Item	Standard Value					
Outline Dimension	105.5(W) x 67.2 (L) x 4.9(H)	mm				
Ink Opening	97.1 (W) * 55.9 (L)	mm				

#### LCD panel

Item	Standard Value	Unit		
Active Area	95.04 (W) x 53.86 (L)			
Pixel Size	0.198 (W) * 0.198 (H)	mm		

Note : For detailed information please refer to LCM drawing



# **1.3 Absolute Maximum Ratings**

#### Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	GND=0	-0.3	+4.6	V
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	Tst	-	-30	+80	°C
Storage Humidity	HD	Ta ≦ 60 °C	-	90	%RH

## **1.4 DC Electrical Characteristics**

Module	GND = 0V, Ta = 25°C									
Item	Symbol	Condition	Min.	Тур.	Max.	Unit				
	VDD	-	3.0	3.3	3.6	V				
Power supply	VGH		12	15	16	V				
	VGL	-	-12	-10	-7	V				
"H" Input Voltage	VIH		0.7*VDD	-	VDD	V				
"L" Input Voltage	VIL	-	GND	-	0.3* GND	V				
"H" Output Voltage	VOH	-	VDD-0.4	-	VDD	V				
"L" Output Voltage	VOL	-	GND	-	GND +0.4	V				
Supply Current	IDD	VDD=3.3V	-	30	45	mA				



# **1.5 Optical Characteristics**

### TFT LCD Panel

VDD =3.3V, Ta=25°C

							- , -	20 0
Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response tim	ne	Tr + Tf	-	-	26	39	ms	Note2
	Тор	θY+		-	60	-		
	Bottom	θY-	CR ≥ 10	-	60	-	Deg	Noto4
Viewing angle	Left	θX-	CR 2 10	-	60	1	Deg.	Note4
	Right	θX+		-	60	-		
Contrast ration	0	CR		500	600	-	1	-
	\//bito	Х		0.26	0.31	0.36		
	White	Y		0.28	0.33	0.38	-	
	Ded	Х		0.55	0.60	0.65		
Color of CIE Coordinate	Red	Y	IF=20mA	0.31	0.36	0.41		Note1
(B/L & LCD & TP)	Croop	Х		0.30	0.35	0.40		NOLET
	Green	Y		0.53	0.58	0.63		
	Blue	Х		0.10	0.15	0.20		
	Diue	Y		0.04	0.09	0.14		
Average Brightr	ness							
Pattern=white dis	splay	D /		100				
		IV	IF=20mA	190	280	-	-	Note1
( B/L & LCD & <sup>-</sup>	ΓP)							
Uniformity		∆B	IF=20mA	70	-	-	%	Note1

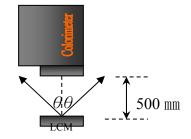
Note1:

 $1 : \Delta B = B(min) / B(max) \times 100\%$ 

2 : Measurement Condition for Optical Characteristics:

- a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
- b : Measurement Distance: 500 ± 50 mm  $\rightarrow$  ( $\theta$ = 0°)
- c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
- d: The uncertainty of the C.I.E coordinate measurement ±0.01 · Average Brightness ± 4%





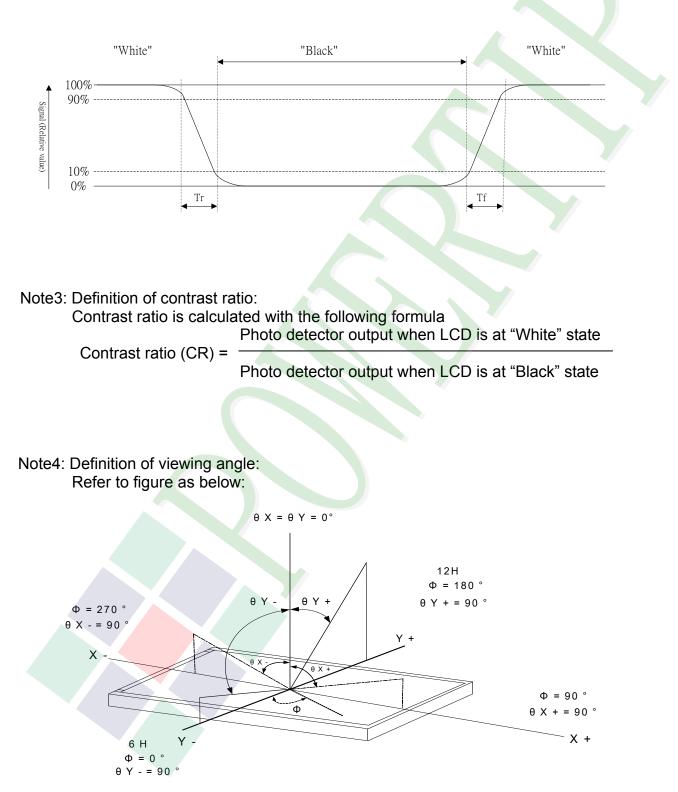
Colorimeter=BM-7 fast



#### Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:





## **1.6 Backlight Characteristics**

### Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current (Each LED)	IF	Ta =25℃	-	30	mA
LED Reverse Voltage (Each LED)	VR	Ta =25℃	-	5	V
Power Dissipation	PD	<b>Ta =25</b> ℃	-	100	mW

#### Electrical / Optical Characteristics

-						
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		18.2	22.8	24.5	V
Average Brightness (Without LCD)	IV	IF=20mA	4500	5400	-	cd/m <sup>2</sup>
CIE Color Coordinate	Х		0.26	0.29	0.32	
(Without LCD)	Y		0.26	0.29	0.32	-
Color			White			

Internal Circuit

PIN(A) ∽ —• PIN(K)

Other Description

Item	Conditions	Description
Life Time*1	Ta =25℃ IF= 20mA	50,000 hrs

\*1 : The "LED life time" is defined as the module brightness decrease to 50% original

brightness at Ta=25°C and IL=20mA. The LED lifetime could be decreased if operating IL is lager than 20 mA.



## 1.7 Touch Panel Characteristics

Features

reatures			-									
	ltem			Standard Value								
Touch	Panel Size			4.3"								
Tou	ch type			Projective capacitive touch panel								
Input	t Method					Fir	nger C	or Conduct	tive Pen			
Suppor	t Operation						5 I	Points touc	ch			
Outpu	t Interface							l <sup>2</sup> C				
	IC							HY4635				
l <sup>2</sup> C Addr	066											
Bit 7	Bit 6	Bi	it 5	F	Bit 4	Bi	t 3	Bit 2	2 Bit	1	Bit	0
0	1		1	L	<u>1</u>		0	0			R/V	
-	Maximum	Ratir	nas								1	•
	ltem			Sy	rmbol		Со	ndition	Min.	Ма	X.	Unit
Operating	Temperatu	re		-	Гор			-	-20	+7	0	°C
Storage	Temperature	e		-	Тѕт				-30	+8	0	°C
DC Elect	rical Chara	cteris	stics									
I	tem		Sym	bol	Cor	ndition		Min.	Тур.	Ма	Х.	Unit
Power Su	upply Voltage	е	TPVI	DD		-		2.8	3.3	3.6	5	V
Optical C	Characteris	tics							ı			
	ltem			Standard Value						Unit		
Total light	transmittan	ce					85%	or more				-
ŀ	Haze						3%	or less				-
ŀ	Haze			3% or less								

## T/P PIN

Pin No.	Symbol	Function
1	TPGND	TP Ground
2	TPVDD	TP VDD
3	SCL	I <sup>2</sup> C Clock
4	SDA	I <sup>2</sup> C Data
5	INT	Interrupt Output
6	XRES	Chip Reset Input, Negative Edge Trigger



#### Touch Panel IC Read/Write description & Register Mapping

Reference : HYCON Driver Porting Reference Guide.

			••••							
Address	Register description	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
0x92	GAIN	R/W		Sensitivity setting, setting range : 05						

Note 1: HYCON I<sup>2</sup>C Sensitivity command:

Application reference: Register 0x92=02(Default) Register 0x92=03 Register 0x92=04 Register 0x92=05

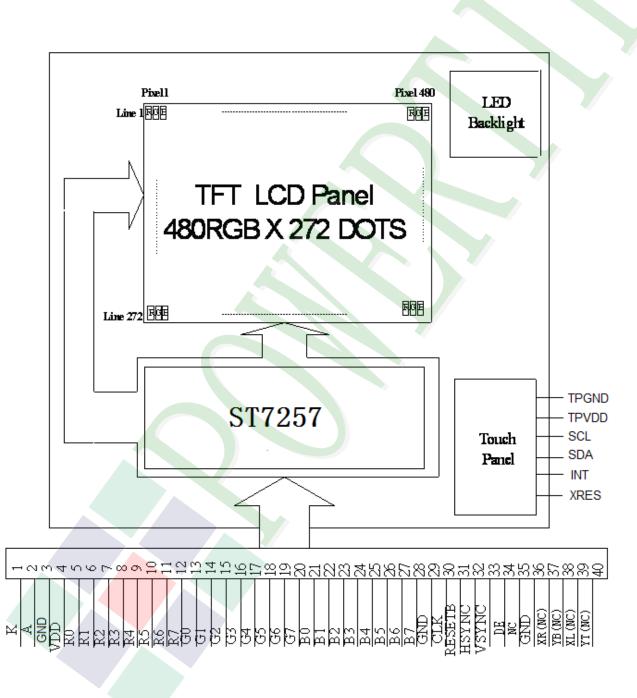
without cover lens Air gap 0.15mm with cover glass 1mm Air gap 0.15mm with cover glass 2mm Air gap 0.15mm with cover glass 3-5mm



# 2. MODULE STRUCTURE

## 2.1 Counter Drawing

- 2.1.1 LCM Mechanical Diagram
  - \* See Appendix
- 2.1.2 Block Diagram



POWERTIP

# 2.2 Interface Pin Description

Pin No.	Symbol	Function				
1	K	Power supply for LED Backlight cathode input				
2	А	ower supply for LED Backlight anode input				
3	GND	Ground				
4	VDD	Digital power				
5	R0	Red data bit 0				
6	R1	Red data bit 1				
7	R2	Red data bit 2				
8	R3	Red data bit 3				
9	R4	Red data bit 4				
10	R5	Red data bit 5				
11	R6	Red data bit 6				
12	R7	Red data bit 7				
13	G0	Green data bit 0				
14	G1	Green data bit 1				
15	G2	Green data bit 2				
16	G3	Green data bit 3				
17	G4	Green data bit 4				
18	G5	Green data bit 5				
19	G6	Green data bit 6				
20	G7	Green data bit 7				

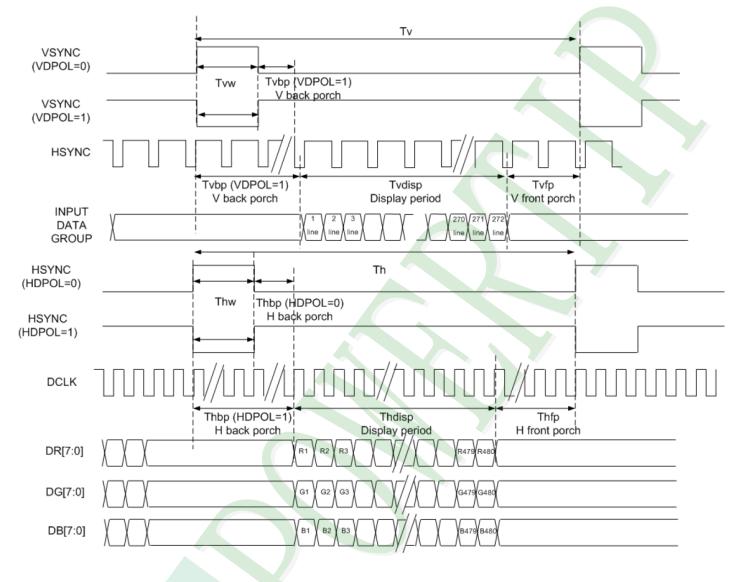


Pin No.	Symbol	Function			
21	B0	Blue data bit 0			
22	B1	e data bit 1			
23	B2	ue data bit 2			
24	B3	Blue data bit 3			
25	B4	Blue data bit 4			
26	B5	Blue data bit 5			
27	B6	Blue data bit 6			
28	B7	Blue data bit 7			
29	GND	Ground			
30	CLK	Dot data clock			
31	DISP	Display control / standby mode selection "High" : Normal display			
32	HSYNC	Horizontal sync input			
33	VSYNC	Vertical sync input			
34	DE	Data input enable. Active High to enable the data input			
35	N.C	Not Connect.			
36	GND	Ground			
37	XR	Not Connect.			
38	YB	Not Connect.			
39	XL	Not Connect.			
40	YT	Not Connect.			



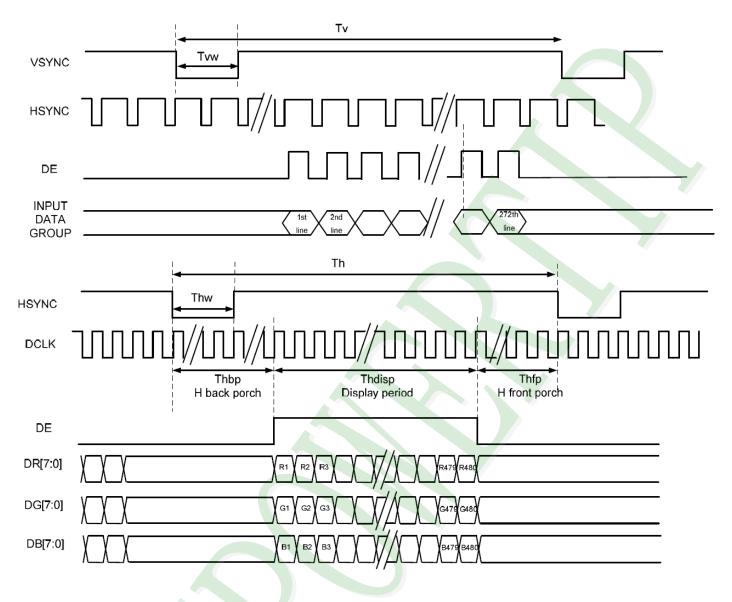
# 2.3 Timing Characteristics

### 2.3.1 SYNC Mode



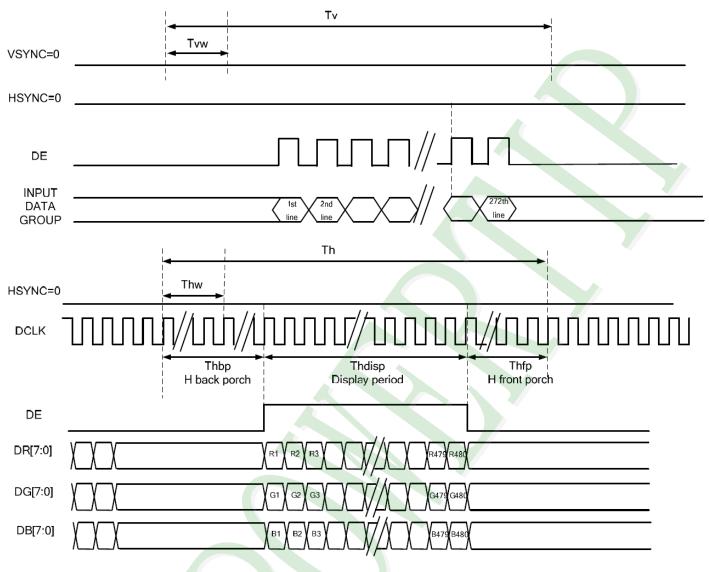


### 2.3.2 SYNC-DE Mode





#### 2.3.3 DE Mode





### 2.3.4 Parallel 24-bit RGB Input Timing Table

		480 <b>RGB</b> X 2	72 Reso	olution	Timing 1	「able	
	ltem	Symbol	Min.	Тур.	Max.	Unit	Remark
DCLK Free	quency	Fclk	8	9	12	MHz	
DCLK Peri	od	Tclk	83	111	125	ns	
HSYNC	Period Time	Th	485	531	598	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	43	DCLK	By H_Blanking setting
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	75	DCLK	
VSYNC	Period Time	Τv	276	292	321	Н	
	Display Period	Tvdisp		272		Н	
	Back Porch	Tvbp	2	12	12	Н	By V_Blanking setting
	Front Porch	Tvfp	2	8	37	Н	
	Pulse Width	Tvw	2	4	37	Н	/

Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

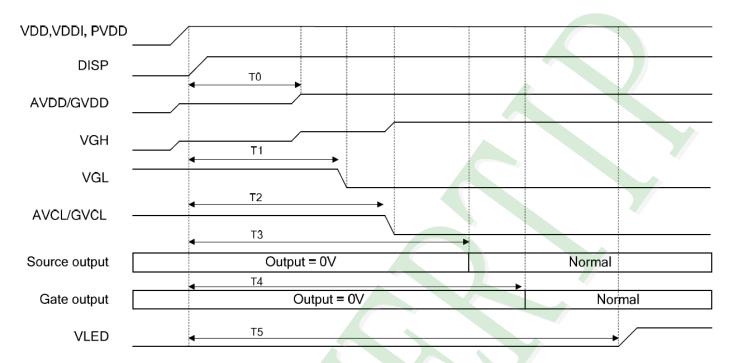
	4	480RGB X 2	40 Reso	olution	Timing 1	able	
	ltem	Symbol	Min.	Тур.	Max.	Unit	Remark
DCLK Free	quency	Fclk	8	9	12	MHz	
DCLK Peri	od	Tclk	83	111	125	ns	
HSYNC	Period Time	Th	485	531	598	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	43	DCLK	By H_Blanking setting
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	75	DCLK	
VSYNC	Period Time	Tv	244	260	321	Н	
	Display Period	Tvdisp		240		Н	
	Back Porch	Tvbp	2	12	12	Н	By V_Blanking setting
	Front Porch	Tvfp	2	8	37	Н	
	Pulse Width	Tvw	2	4	37	Н	

Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

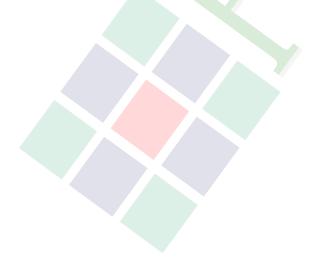


#### 2.3.5 Power Sequence

#### POWER ON

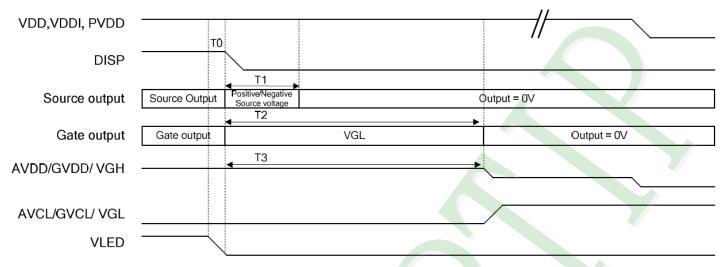


Symbol	Description	Min. Time	Unit
Т0	DISP="High" to AVDD/GVDD voltage stability	40	ms
T1	DISP="High" to VGL voltage stability	50	ms
T2	DISP="High" to AVCL/GVCL stability	70	ms
Т3	DISP="High" to Source output	100	ms
T4	DISP="High" to Gate output	110	ms
T5	Black Turn on	130	ms





#### POWER OFF

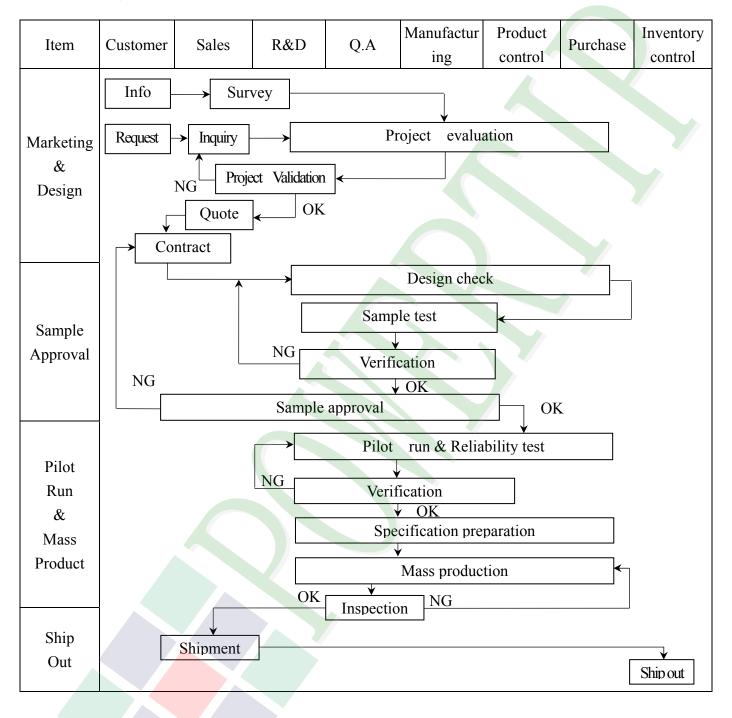


Symbol	Description	Min. Time	Unit
Т0	Backlight turn off to DISP="Low"	5	ms
T1	DISP="Low" to Source output disable	20	ms
T2	DISP="Low" to Gate output disable	50	ms
Т3	DISP="Low" to Gate output disable	50	ms



# **3. QUALITY ASSURANCE SYSTEM**

### 3.1 Quality Assurance Flow Chart



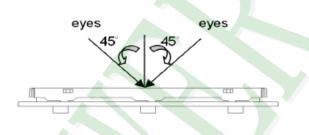


Item	Customer	Sales	R&D	Q.A	Manufactu ring	Product control	Purchase	Inventory control
Sales Service	Info	Claim sis report	[	Trackin	Failure an Corrective			
Q.A Activity	1. ISO 9001 3. Equipmen 5. Standardi		n		ocess improv Education An			

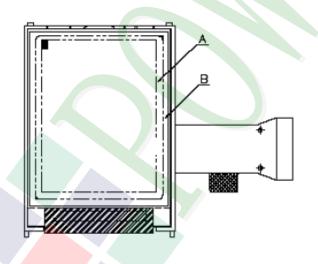


## **3.2. Inspection Specification**

- Scope : The document shall be applied to TFT-LCD Module for 3, 5" ~15" (Ver.B01).
- ◆Inspection Standard:MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
- ◆Defect Level:Major Defect AQL: 0.4 ; Minor Defect AQL: 1.5
- ♦OUT Going Defect Level ∶ Sampling.
- $\clubsuit$ Standard of the product appearance test :
  - a. Manner of appearance test :
  - (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
  - (2). The test direction is base on about around  $45^{\circ}$  of vertical line.



(3). Definition of area.



A area : viewing area

**B** area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



#### ◆Specification For TFT-LCD Module 3. 5″~15″:

Spe	cification For TFT-L	CD Module 3. 5″~15″:	(Ver.B01)				
NO	Item	Criterion	Level				
		1. 1The part number is inconsistent with work order of production.					
01	Product condition	1. 2 Mixed product types.	Major				
		1. 3 Assembled in inverse direction.	Major				
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major				
03	Outline dimension	3.1 Product dimension and structure must conform to structure diagram.	Major				
		4. 1 Missing line character and icon.	Major				
		4. 2 No function or no display.	Major				
	Electrical Testing	4. 3 Display malfunction.					
04		4. 4 LCD viewing angle defect.					
		4. 5 Current consumption exceeds product specifications.					
		4. 6 Mura can not be seen through 5% ND filter. (Mura : Under the normal examination angle of view,the picture has the non-uniform phenomenon.)					
		Item Acceptance (Q'ty)					
		Bright Dot $\leq 4$					
	Dot defect	Dot Dark Dot ≦ 5					
		Defect Joint Dot ≦ 3					
05	(Bright dot 丶 Dark dot)	Total $\leq 7$	Minor				
00	On -display	<ul> <li>5. 1 Inspection pattern : full white , full black , Red , Green and blue screens.</li> <li>5. 2 It is defined as dot defect if defect area &gt;1/2 dot.</li> </ul>					
		<ul> <li>5.3 The distance between two dot defect ≥5 mm.</li> <li>5.4 Bright dot that can not be seen through 5% ND filter.</li> </ul>					



<b>♦</b> Spee	cification For TF1	T-LCD Module 3, 5″~15″:	(Ver.B01)					
NO	Item	Criterion						
	Black or white dot \ scratch \ contamination Round type	3. 1 Round type (Non-display or display) :Dimension (diameter : $\Phi$ )Acceptance (Q'ty)A areaB area $\Phi \leq 0.25$ Ignore $0.25 < \Phi \leq 0.50$ 5 $\Phi > 0.50$ 0Ignore5						
06	Round type $\begin{array}{c} \downarrow x \\ \hline \\ \Psi \\ \hline \\ L \\ \hline \\ \Psi \\ \hline \hline \\ \Psi \\ \hline \\ \Psi \\ \hline \\ \Psi \\ \hline \hline \hline \hline$	6. 2 Line type(Non-display or display) : $ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Minor					
07	Polarizer Bubble	Acceptance (Q'ty)Dimension (diameter : $\Phi$ )A areaB area $\Phi \leq 0.25$ Ignore $0.25 < \Phi \leq 0.50$ 4 $0.50 < \Phi \leq 0.80$ 1 $\Phi > 0.80$ 0Total5	Minor					



# Specification For TFT-LCD Module 3, 5″ ~15″ : (Ver.B01) NO Item Criterion Level Symbols : Y: The width of crack. X : The length of crack Z : The thickness of crack W: terminal length t : The thickness of glass a : LCD side length 8.1 General glass chip: 8.1.1 Chip on panel surface and crack between panels: 08 Minor The crack of glass [NG] (OK) Seal width Х Y Z Crack can't enter ≦1/2 **t** ≦ a viewing area Crack can't exceed the ≦ a $1/2 t < Z \leq t$ half of SP width.

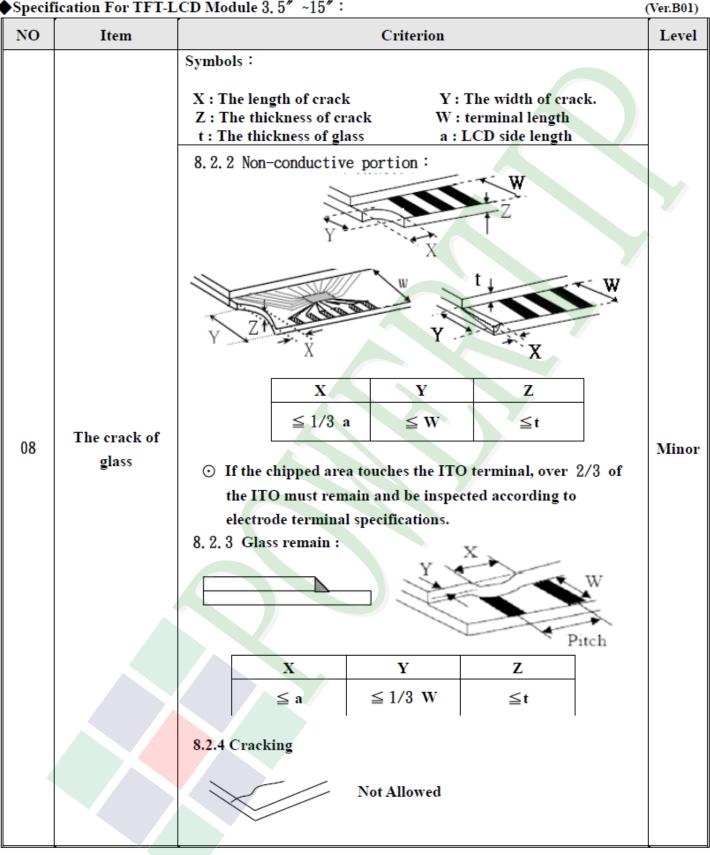


#### ◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Module 3. 5″~15″: Criterion				
		Z : The thi t : The thi	gth of crack ckness of crack ckness of glass ner crack :	Y : The W : teri	width of crack. ninal length ) side length	Level
		$ \begin{array}{c} \mathbf{X} \\ \leq 1/5 \mathbf{a} \\ \leq 1/5 \mathbf{a} \end{array} $	Y Crack can't e viewing are Crack can't exce half of SP wie	eed the 1/9 f	$z$ $\leq 1/2 t$ $< Z \leq 2 t$	
08	The crack of glass		sion over termin p on electrode p		Y Z	Minor
		Front Back	$\begin{array}{c} X \\ \leq a \\ \leq a \end{array}$		$\frac{Z}{\leq t}$ $\leq 1/2 t$	



#### Specification For TFT-LCD Module 3. 5″~15″:





#### ◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9. 2 Backlight doesn't light or color is wrong.	Majoı
		9. 3 Illumination source flickers when lit.	Majoı
10	General appearance	10. 1 Pin type ` quantity ` dimension must match type in structure diagram.	Majoı
		10. 2 No short circuits in components on PCB or FPC .	Majoı
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Majoi
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Mino
		10. 5 The folding and peeled off in polarizer are not acceptable.	Mino
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC ) is ≤1.5 mm.	Mino



# 4. RELIABILITY TEST

## 4.1 Reliability Test Condition

(Ver.B01)

4.1			
NO.	TEST ITEM	TEST CONDITION	
1	High Temperature Storage Test	Keep in +80 ±2℃ 240 hrs Surrounding temperature, then storage at normal condition 4hrs.	
2	Low Temperature Storage Test	Keep in −30 ±2°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.	
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 240 hrs Surrounding temperature, then storage at normal condition 4hrs.	
4	Temperature Cycling Storage Test	$30^{\circ}C \rightarrow +25^{\circ}C \rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ $(30 \text{mins})  (5 \text{mins})  (30 \text{mins})  (5 \text{mins})$ $20 \text{ Cycle}$ Surrounding temperature, then storage at normal condition 4hrs.	
5	ESD Test	Air Discharge:Contact Discharge:Apply 15 KV with 10 timesApply 10 KV with 10 timesDischarge for each polarity +/-discharge for each polarity +/-1. Temperature ambiance : 15°C ~35°C2. Humidity relative : 30%~60%3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%4. Discharge Resistance(Rd) : 330 Ω±10%5. Discharge, mode of operation :Single Discharge (time between successive discharges at least 1 sec)(Tolerance if the output voltage indication : ±5%)	
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X \ Y \ Z) duration for 2 Hrs</li> </ol>	
7	Drop Test (Packaged)	Packing Weight (Kg)         Drop Height (cm)           0 ~ 45.4         122           45.4 ~ 90.8         76           90.8 ~ 454         61           Over 454         46	



# **5. PRECAUTION RELATING PRODUCT HANDLING**

### 5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

### 5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM
- 5.2.10 Caution!( LCM products with Capacitive Touch Panel) Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
  Therefore, the touch panels to be thereughly tested inside the target application.

Therefore, the touch needs to be thoroughly tested inside the target application.

- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.
- 5.2.12 Double-sided tape designed to be attach with the customer's mechanical device, please follow up the rules and regulations published by the original manufacturer of double-sided tape for the attachment operation.

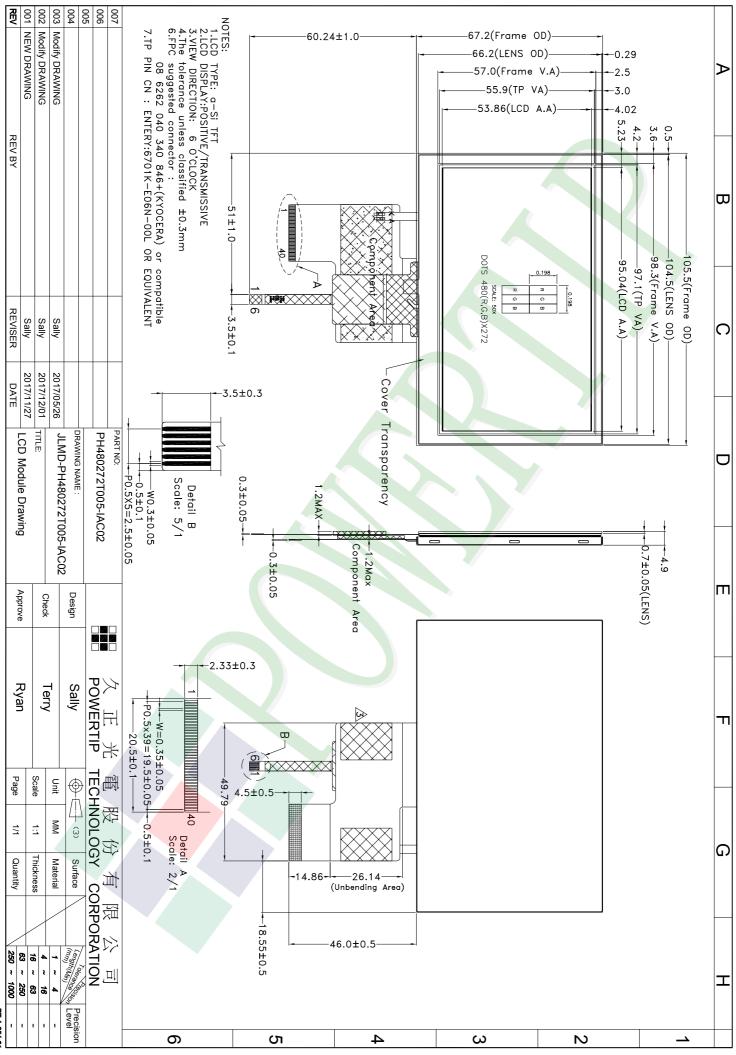
### 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}C \pm 5^{\circ}C$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

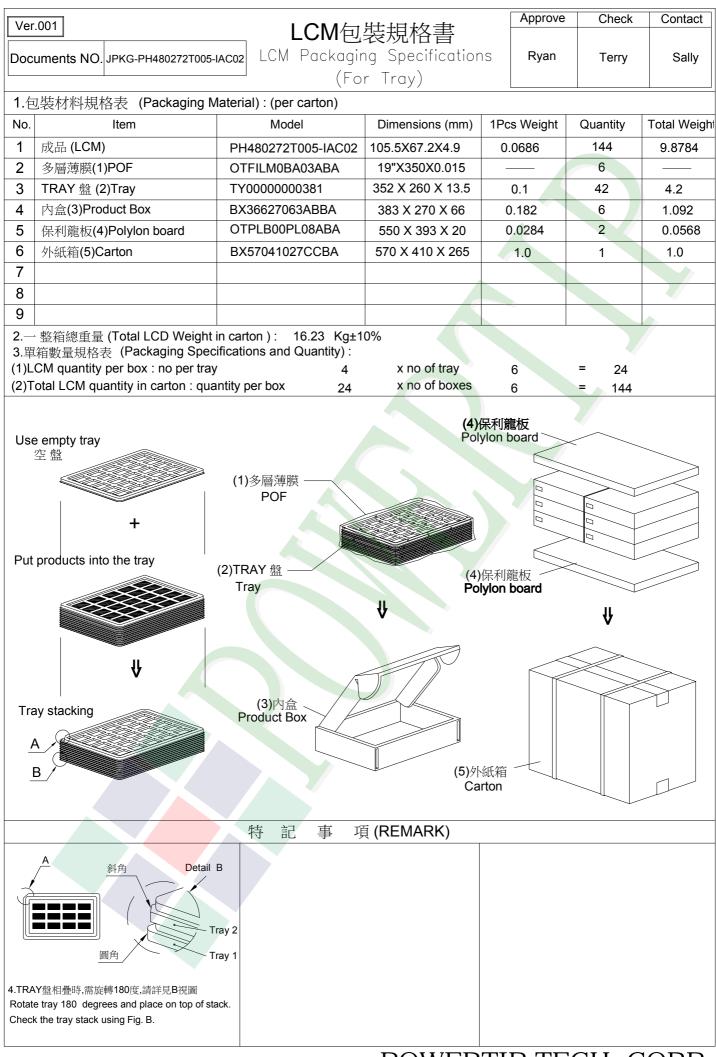
#### **5.4 TERMS OF WARRANTY**

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



PT-A-054-01



# POWERTIP TECH. CORP.